



- NOTES:
1. PLATING THICKNESS:
ELECTRO Ni: 1.27~8.89 MICRON (SOLDER PADS)
ELECTRO Au: 0.70~1.20 MICRON (SOLDER PADS)
 2. CAMBER: 0.05mm MAX.
 3. * MARK TO BE MATERIAL DIMENSION.
 4. EXPOSURE OF CERAMIC SURFACE OCCURRED BY MISALIGNMENT OF THE UPPER LAYER, SHALL BE ALLOWED.
 5. ■ PART TO BE SHOWN AS SIDE METALLIZED PATTERN.
 6. SOLDERING METHOD OF THIS PRODUCT SHALL BE SOLDER WELD.

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DBTAIL A

TOLERANCE	REVISION	SEE ATTACHED EXCEPTIONS SHEET.				TITLE
$\pm 1\%$ ± 0.13 ± 0.13 ± 0.13	SCALE	DIMENSION	PROJECTION	CUSTOMER DWG NO.	REV.	7X5 X-TAL PKG
	15 : 1	mm	3rd			
MATERIAL	APPROVED	CHECKED	ENGR	CHECKED	DESIGNED	PART NO.
90%MIN. Al ₂ O ₃ (INA-301B BLACK)	Shigetomi	Kaike	Ohba	Kumura	Sugi	S5070XTAL1
	May.09.03	May.09.03	May.09.03	May.09.03	May.09.03	REV. 0
						DWG NO. VCA030915-40
						SHT/OF 1/6